

3.0x2.5mm SURFACE MOUNT LED LAMP

Part Number: APBL3025SURKCGK-F01

Hyper Red Green

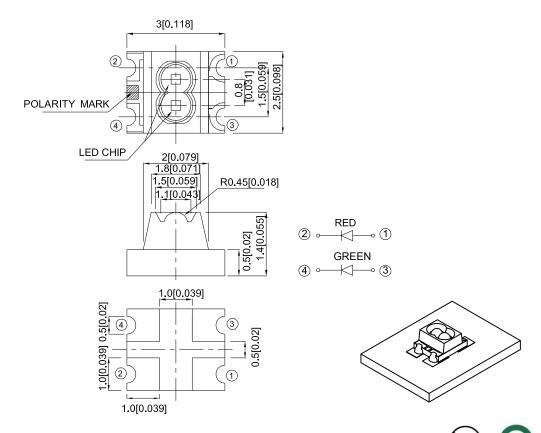
Features

- 3.0mmx2.5mm SMT LED, 1.4mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for back light and indicator.
- Inner lens type.
- Moisture sensitivity level : level 3.
- Package: 2000pcs / reel.
- RoHS compliant.

Descriptions

- The Hyper Red source color devices are made with Al GaInP on GaAs substrate Light Emitting Diode.
- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

SPEC NO: DSAF1335 **REV NO: V.9A** DATE: MAY/04/2015 PAGE: 1 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: F.T.Liu ERP: 1203000922

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APBL3025SURKCGK-F01	Hyper Red (AlGaInP)	- Water Clear	400	600	- 100°
			*80	*200	
	Green (AlGalnP)		55	120	
			*55	*120	

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
 Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green	645 574		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red Green	630 570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green	28 20		nm	IF=20mA
С	Capacitance	Hyper Red Green	35 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green	1.95 2.1	2.5 2.5	V	IF=20mA
lr	Reverse Current	Hyper Red Green		10 10	uA	V _R = 5V

Notes:

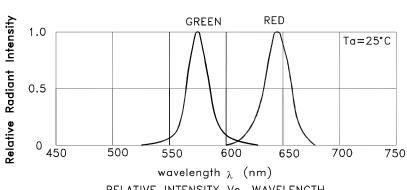
- Wavelength: +/-1nm.
 Forward Voltage: +/-0.1V.
 Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Green	Units		
Power dissipation	75	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	185	150	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

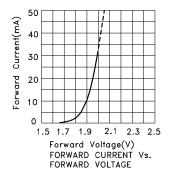
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

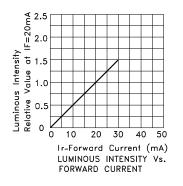
DATE: MAY/04/2015 SPEC NO: DSAF1335 **REV NO: V.9A** PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** ERP: 1203000922 DRAWN: F.T.Liu

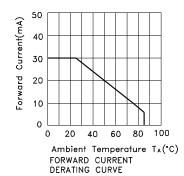


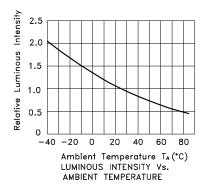
RELATIVE INTENSITY Vs. WAVELENGTH

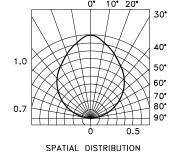
APBL3025SURKCGK-F01 **Hyper Red**





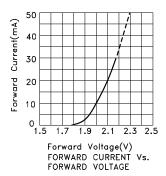


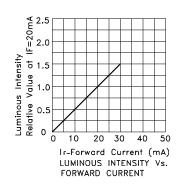


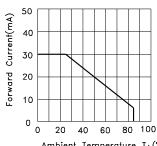


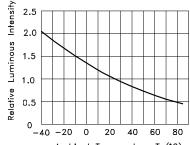
SPEC NO: DSAF1335 **REV NO: V.9A** DATE: MAY/04/2015 PAGE: 3 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** ERP: 1203000922 DRAWN: F.T.Liu

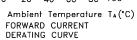
Green



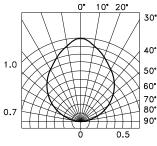












SPATIAL DISTRIBUTION

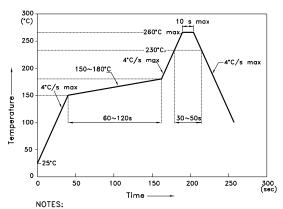
 SPEC NO: DSAF1335
 REV NO: V.9A
 DATE: MAY/04/2015
 PAGE: 4 OF 6

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: F.T.Liu
 ERP: 1203000922

APBL3025SURKCGK-F01

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



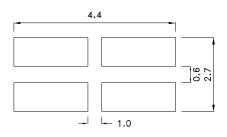
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

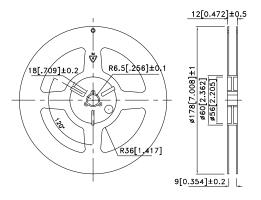
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units : mm)

TAPE 4.0±0.1 0.25±0.1 2.0±0.05 4.0±0.1 1.55±0.05 1 75±0 1 1.55±0.1 2 8 0±0 3 3.5 ± 0.05 3 Α 2.8±0.1 A-A SECTION

SPEC NO: DSAF1335 **APPROVED: WYNEC**

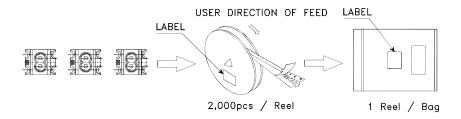
REV NO: V.9A CHECKED: Allen Liu

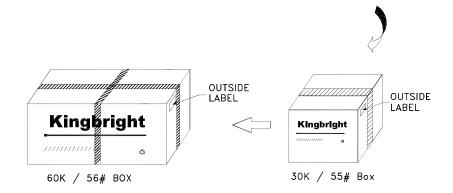
DATE: MAY/04/2015 DRAWN: F.T.Liu

PAGE: 5 OF 6 ERP: 1203000922

PACKING & LABEL SPECIFICATIONS

APBL3025SURKCGK-F01







Terms and conditions for the usage of this document

- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- 4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- 5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6. All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

 SPEC NO: DSAF1335
 REV NO: V.9A
 DATE: MAY/04/2015
 PAGE: 6 OF 6

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: F.T.Liu
 ERP: 1203000922